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- Compares Two 8-Bit Words
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

#### description

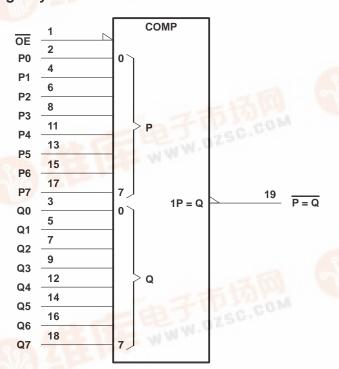
These identity comparators perform comparisons on two 8-bit binary or BCD words. They provide  $\overline{P} = \overline{Q}$  outputs.

The SN54F521 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74F521 is characterized for operation from 0°C to 70°C.

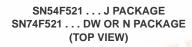
**FUNCTION TABLE** 

INPU	JTS	OUTPUT
P, Q	OE	P = Q
P = Q	L	Lac
P≠Q	X	Н
X	Н	LUHO ZS

## logic symbol†

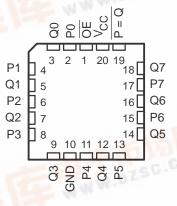


<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

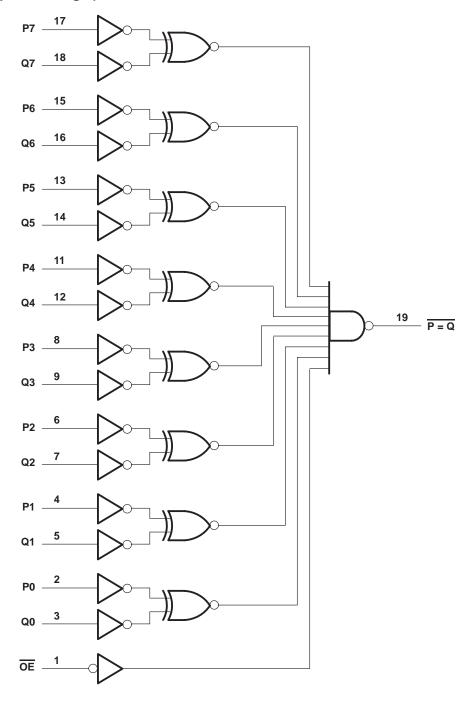


1		$\overline{}$		
OE [	1	O	20	Vcc
P0 [	2		19	P = Q
Q0 [	3		18	] Q7
P1 [	4		17	] P7
Q1 [	5		16	] Q6
P2 [	6		15	] P6
Q2 [	7		14	] Q5
P3 [	8		13	] P5
Q3 [	9		12	] Q4
GND [	10	)	11	] P4
,				

## SN54F521 . . . FK PACKAGE (TOP VIEW)



### logic diagram (positive logic)



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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V <sub>CC</sub>		0.5 V to 7 V
Input current range		30 mA to 5 mA
Voltage range applied to any output in t	the high state	$\dots$ -0.5 V to V <sub>CC</sub>
Current into any output in the low state		40 mA
Operating free-air temperature range:	SN54F521	. −55°C to 125°C
	SN74F521	0°C to 70°C
Storage temperature range		. −65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.

#### recommended operating conditions

		SN54F521			S	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNII
VCC	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V <sub>IH</sub>	High-level input voltage	2			2			V
$V_{IL}$	Low-level input voltage			0.8			0.8	V
liK	Input clamp current			-18			-18	mA
ІОН	High-level output current			<b>–</b> 1			- 1	mA
loL	Low-level output current			20			20	mA
TA	Operating free-air temperature	-55		125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		S	SN54F521			SN74F521		
			MIN	TYP <sup>‡</sup>	MAX	MIN	TYP <sup>‡</sup>	MAX	UNIT
VIK	$V_{CC} = 4.5 \text{ V},$	$I_I = -18 \text{ mA}$			-1.2			-1.2	V
Vou	$V_{CC} = 4.5 \text{ V},$	$I_{OH} = -1 \text{ mA}$	2.5	3.4		2.5	3.4		V
VOH	$V_{CC} = 4.75 \text{ V},$	$I_{OH} = -1 \text{ mA}$				2.7			ı v
V <sub>OL</sub>	$V_{CC} = 4.5 \text{ V},$	$I_{OL} = 20 \text{ mA}$		0.3	0.5		0.3	0.5	V
lį	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 7 V			100			100	μΑ
lн	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 2.7 V			20			20	μΑ
I <sub>IL</sub>	$V_{CC} = 5.5 \text{ V},$	V <sub>I</sub> = 0.5 V			- 0.6			- 0.6	mA
los§	$V_{CC} = 5.5 \text{ V},$	V <sub>O</sub> = 0	-60		-150	-60		-150	mA
Icc	V <sub>CC</sub> = 5.5 V,	See Note 2		21	32		21	32	mA

<sup>‡</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .



<sup>§</sup> Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second. NOTE 2: I<sub>CC</sub> is measured with all inputs at 4.5 V.

### SN54F521, SN74F521 8-BIT IDENTITY COMPARATORS

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#### switching characteristics (see Note 3)

PARAMETER	FROM (INPUT)		$V_{CC}$ = 5 V, $C_{L}$ = 50 pF, $R_{L}$ = 500 $\Omega$ , $T_{A}$ = 25°C			$V_{CC}$ = 4.5 V to 5.5 V, $C_L$ = 50 pF, $R_L$ = 500 $\Omega$ , $T_A$ = MIN to MAX $^{\dagger}$				UNIT	
		′F521			SN54	F521	SN74F521				
			MIN	TYP	MAX	MIN	MAX	MIN	MAX		
<sup>t</sup> PLH	P or Q	<u> </u>	2.7	6.6	10	2.7	14	2.7	11	ns	
<sup>t</sup> PHL	POIQ	$\overline{P} = Q$	Y P=Q	3.7	6.6	10	3.2	12	3.2	11	115
<sup>t</sup> PLH	ŌĒ	P = Q	2.2	4.6	6.5	2.2	8.5	2.2	7.5	ns	
<sup>t</sup> PHL			2.7	6.1	9	2.7	13.5	2.7	10	115	

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. NOTE 3: Load circuits and waveforms are shown in Section 1.



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